



Attorney's Docket No.: 42P13856D

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Patent Application of:)

Rahul N. Manepalli et al.)

Examiner: Dolan, Jennifer M.)

Application No.: 10/774,155)

Art Unit: 2813)

Filed: February 5, 2004)

For: AN UNDERFILLING PROCESS IN)
A MOLDED MATRIX ARRAY)
PACKAGE USING FLOW FRONT)
MODIFYING SOLDER RESIST)

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE

Dear Sir:

This is in response to the Office Action mailed September 2, 2005. Applicant respectfully requests the Examiner to enter the following amendments and consider the following remarks.

FIRST CLASS CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage in an envelope addressed to MAIL STOP _____

COMMISSIONER FOR PATENTS, P.O. Box 1450, Alexandria, VA 22313-1450

U.S. Patent and Trademark Office, Washington, D.C. 20231 on November 30, 2005

Date of Deposit

Teresa Mattox

Name of Person Mailing Correspondence

Teresa Mattox

Signature

November 30, 2005

Date